

ICMSET 2023

2023 the 12th International Conference on Material Science and Engineering Technology

November 24-26, 2023 | Fukuoka, Japan

 **ICMSET**
CALL FOR PAPERS

2023 the 12th International Conference on Material Science and Engineering Technology (ICMSET 2023), will be held in Fukuoka, Japan during November 24-26, 2023. This event will include the participation of renowned keynote speakers, oral presentations, posters sessions related to the topics dealt with in the Scientific Program as well as an attractive social and cultural program. Topics of interest for submission include, but are not limited to:

- | | |
|---------------------------|---------------------------------------|
| (01) Advanced materials | (11) Nanotechnology |
| (02) Biomaterials | (12) Materials Characterization |
| (03) Composite materials | (13) Materials Engineering |
| (04) Polymer science | (14) Materials Forming |
| (05) Renewable materials | (15) Materials Processing |
| (06) Functional materials | (16) Materials Sustainability |
| (07) Nano materials | (17) Adhesion and Adhesives |
| (08) Chemical materials | (18) Biomass Composites |
| (09) 3D materials | (19) Coatings and Surface Engineering |
| (10) Cryogenic material | (20) Natural Fiber Composites |

Organizing Committees

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Keynote Speaker



Prof. Masahiro Furuya

Waseda University, Japan

Prof. Ramesh K. Agarwal

Washington University in St. Louis, USA



Prof. Wenjun Zhang

City University of Hong Kong, Hong Kong

Conference Proceedings

After a careful reviewing process, all accepted papers after proper registration and presentation, will be published into *Journal of Physics: Conference Series (JPCS)*, which submitted for **Ei Compendex, Scopus**, Thomson Reuters (WoS), Inspec index, et al.

- ICMSET 2022 - Materials Science Forum(MSF) Vol. 1087, ISBN: 978-3-0357-1838-6
- ICMSET 2021 - Materials Science Forum(MSF) Vol. 1053, ISBN: 978-3-0357-2684-8
- ICMSET 2020 - Materials Science Forum(MSF) Vol. 1023, ISBN: 978-3-0357-1784-6
- ICMSET 2019 - Materials Science Forum(MSF) Vol. 998, ISBN: 978-3-0357-1606-1
- ICMSET 2018 - Materials Science Forum(MSF) Vol. 950, ISBN: 978-3-0357-1784-6
- ICMSET 2017 - Materials Science Forum(MSF) Vol. 917, ISBN: 978-3-0357-1213-1
- ICMSET 2016 - Materials Science Forum(MSF) Vol. 890, ISBN: 978-3-0357-1028-1

Paper Submission

Submissions via the link:

<https://www.morressier.com/call-for-papers/64b5416430d43b0012d61ddc>

Both Abstract and Full paper are acceptable for submission. **An invitation letter can be provided after registration.**

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